

Overview of detectors at SACLA and introduction of new detectors under development

T. Kameshima & <u>T. Hatsui</u>

On behalf of SACLA detector team

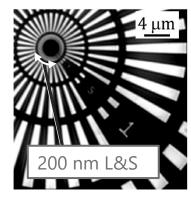
Outlines

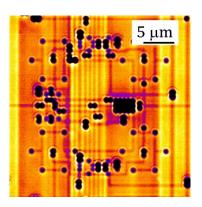
- New detectors to be deployed
 - New variants of KamCam
 - CITIUS
- Summary and discussion points from facility point of view

Details will be presented at Poster #9

KamCam: high spatial resolution X-ray detector

Resolving power





X-ray transmission image of test chart

X-ray transmission image of VLSI

- Indirect lens-coupled detector
- 200 nm L&S resolution achieved
- Field of view was limited to 0.13 mm x 0.13 mm
- So far about 10 detector systems are deployed
 - at SPring-8/SACLA mainly for the beam characterization

T. Kameshima, Optics Letters Vol. 44, Issue 6, pp. 1403 (2019)

New Variants Deployment

In combination with a state-of-a**cendidg tes** ge sensor, the following combination are now achievable. CMOS image sensor spec. 14,192 x 10,640 pixels, 16 bit depth

		Custom lens	Commercial off-the-shelf lenses			
L&S resolution	[nm]	~200	450	600	1000	1900
Field of view	[mm ²]	2.6 x 1.9	7.6 x 5.7	10.3 x 7.7	15.2 x 11.4	53.3x 40.0
Conversion	[e-/X-ray]	10.6 @ 10 keV	1.98 @ 10 keV	1.21 @ 10 keV	0.78 @ 20 keV	0.33 @ 30 keV
DQE	[%]	15 @ 10 keV	42 @ 10 keV	44 @ 10 keV	31 @ 20 keV	21 @ 30 keV

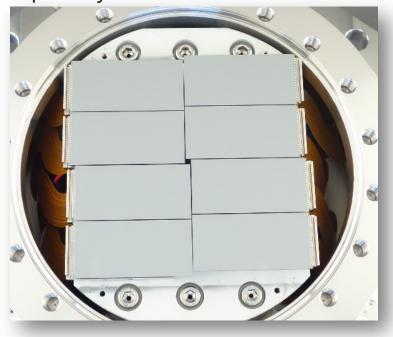
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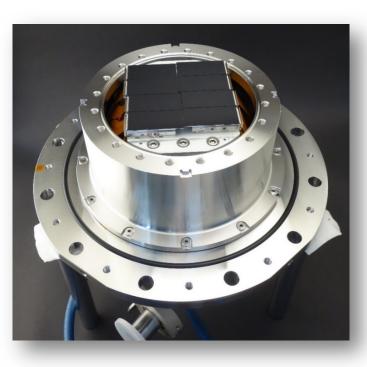
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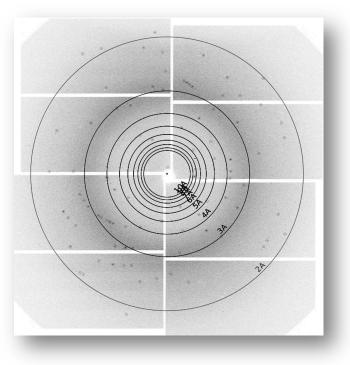
MPCCD at a glance

Kameshima et al., Rev. Sci. Instrum. 85, 033110 (2014)

4 Mpixel system







C. Song, et.al., J. Appl. Cryst. (2014). 47, 188–197.

1st XFEL detector with 50 μ m \Box pixel

Currently, 38 systems, 118 sensors, 59 Mpixels are deployed^{*} since March 2012. After 9 years of operation, the performance is not at the forefront of XFEL detectors.

*) as of Oct. 2020

X-ray Imaging Detector for X-ray diffraction with silicon sensors (< 30 keV)

XFEL facility, SACLA (Since 2012-)

- Workhorse Detector: Multi-port CCDs
 - 50 µm pixel
- CITIUS XFEL variant
 - 72.6 µm pixel

SR facility, SPring-8 (Since 1997-)

- Upgrade to SPring-8 II proposed.
- One of Workhorse detector: to be CITIUS SR
 - 72.6 µm pixel

hatsui@spring8.or.jp

10th, 2021

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CITIUS development History

- April 2013
 - Technical investigation started
- 2014
 - Basic concept and target performance reported in SPring-8-II CDR
- 2015
 - Sony and RIKEN agreed on the development
- March 2016
 - Project Schedule finalized
 - First X-ray Image capture scheduled on June 2020
- Sep. 9th, 2020
 - First Optical Image capture
 - System evaluation started
- Oct. 2nd, 2020
 - First X-ray Image capture
 - Delayed by 3.5 months



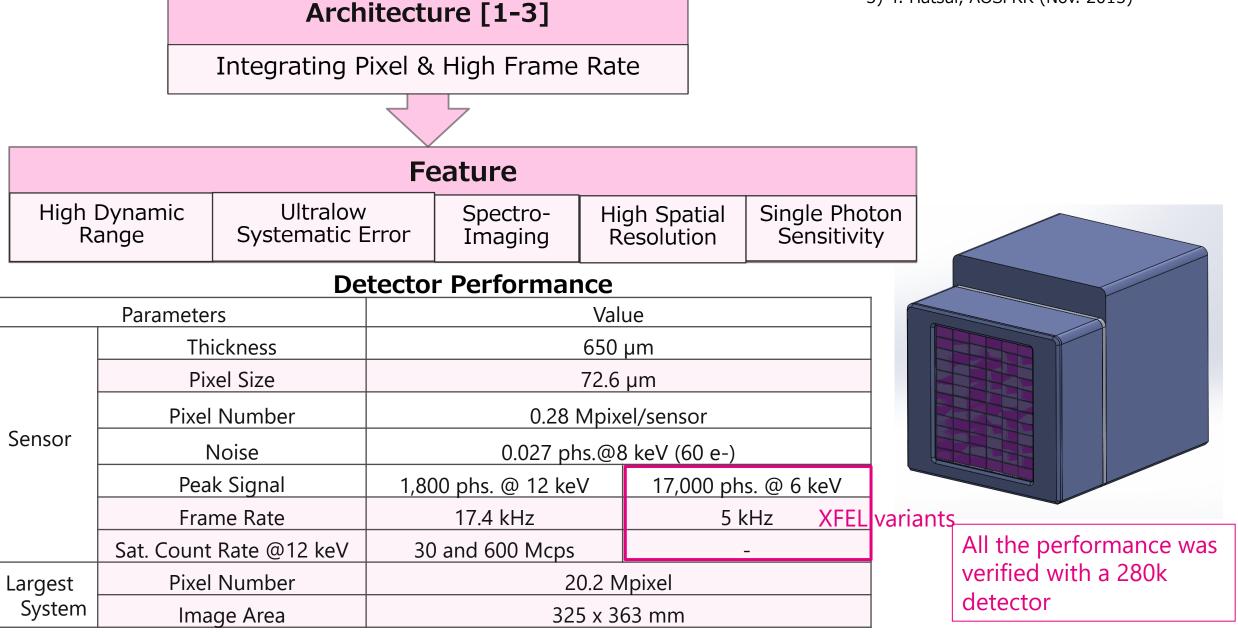


On-site collaborators happy with their first X-ray image taken at Sep. 9th, 2020

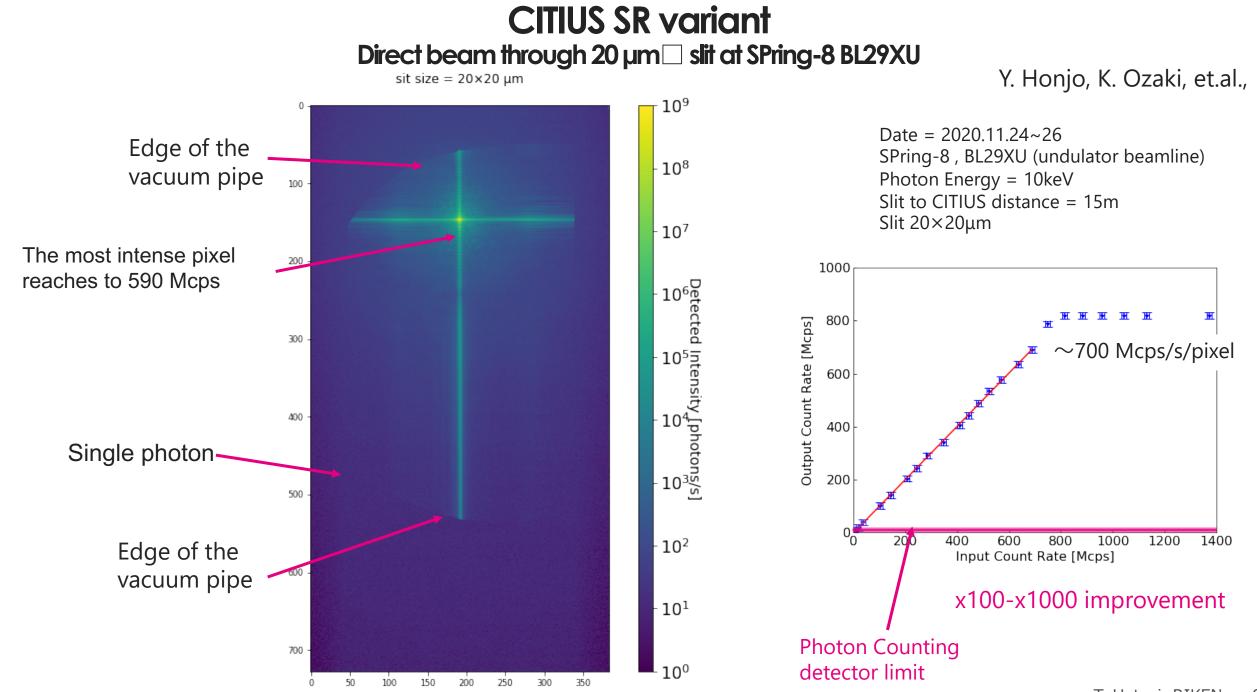
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SPring-8 II CDR (2014) with updated values.
 T. Hatsui, presented at iWorid (June. 2014).
 T. Hatsui, AOSFRR (Nov. 2015)



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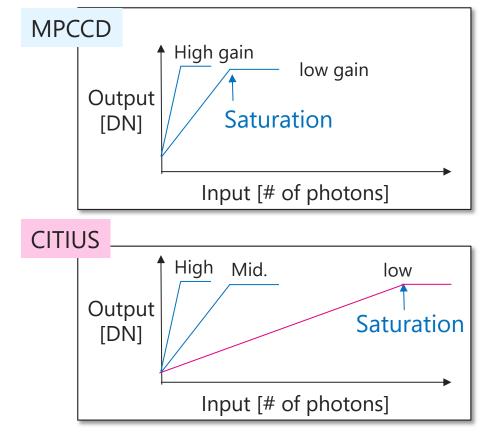
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CITIUS XFEL variant

		V		
Parameters		CITIUS XFEL for SACLA	MPCCD Phase III/III-L	Unit
Sensor	Thickness	650	x2.1 300	μm
	Pixel Size	72.6 µm	x1.5 50	μm
	Pixel Number	0.28	x0.6 0.5	Mpixel/sensor
	Image Format	384 x 728	512 x 1024	pixels
	Noise	60 e- or better	300/60	e-rms
	Peak Signal	17,000	x7 2,400	Phs.@ 6 keV
	Frame Rate	60 (max. 5 kHz)	60 or 30 Hz	
Largest System	Pixel Number	20.2 Mpixel	x 5 4	Mpixel
	Image Area	325 x 363	100 x 100	mm ²
Tiling	Inter-module gap	~ 3 mm	x 3 < 1 mm	

As facility need to be ready for high repetition operation in long term, MPCCD need to be replaced by CITIUS. However, not all the spec. will be better.

Architecture from Calibration point of view



Technology: CCD On-chip Amplifiers: 8 ports / 0.5 Mpixels Analog-to-Digital Conversion: 2 conv./pixel Calibration: port wise

Technology: advanced CMOS image sensor On-chip Amplifiers: 3 / pixel Analog-to-Digital Conversion: 3 conv./pixel Calibration: pixel wise

We are developing a calibration tools so that we do not ask users to calibrate detectors by themselves.

We adopt a scheme similar to MPCCD, i.e., simultaneous digitization for all the gains. This scheme minimizes artifacts such as non-local cross-talks and anomalous behavior at switching point (at the expense of the frame rate). However, in the initial deployment phase, we may see artifacts and we need to have good communications with users.

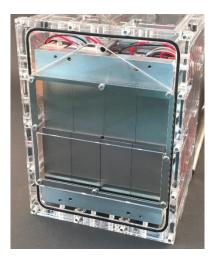
CITIUS: Camera Head Variants (under development)

280k Compact

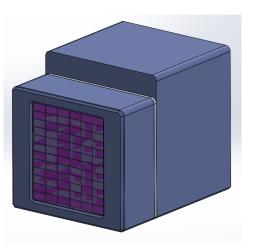


 $36 \times 96 \times 197 \text{ mm}^3$ $\sim 1 \text{ kg}$ Fan-less operation is possible.

2.2M standard



20.2M standard



560k (Linear) Compact



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SACLA goes to higher repetition operation in long term, MPCCD need to be replaced by CITIUS.

However,

- not all the spec. will be better.
- replacement demands significant budget and internal resources.
 We would like to have user comments, especially, on
- Deployment Priority to CITIUS detector
- MPCCD detector not replaceable by CITIUS We are finalizing deployment plan for FY2022-2023 by the end of April 2021.

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Summary and discussion points from facility point of view

• KamCam

- Under development
- Custom DAQ need to be implemented.
- Please get in touch with BL scientist if you are interested in.
- CITIUS
 - Developed for SPring-8-II, and reach > 600 Mcps/pixel
 - For SACLA, it has better performance than MPCCD, but not all the spec.
 - In the long term, MPCCD will be replaced to CITIUS.
 - Replacement demands significant budget and resources.
 - In the initial deployment phase, we may see artifacts and we need to have good communications with users.
 - We are finalizing deployment plan for FY2022-2023 by the end of April 2021.
 - We would like to have user comments, especially, on
 - Deployment Priority to CITIUS detector
 - MPCCD detector not replaceable by CITIUS

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